

Taping Specifications

編帶產品規格

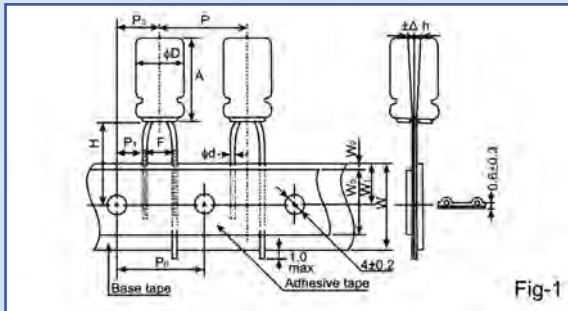


Fig-1

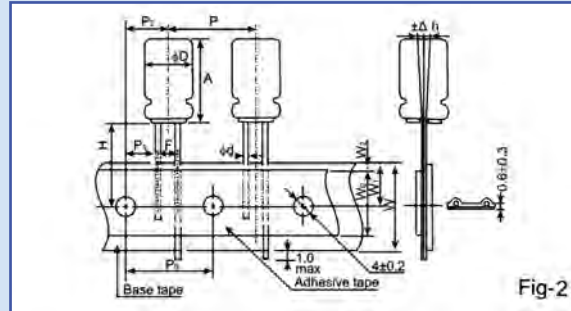


Fig-2

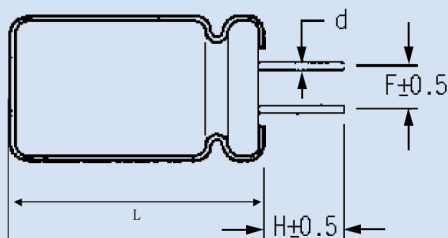
Specifications

Item	Dimensions (mm)	Dimensions (mm)				
		Fig. 1	Fig. 1	Fig. 2	Fig. 2	Fig. 2
Reference Figure		Fig. 1	Fig. 1	Fig. 2	Fig. 2	Fig. 2
Diameter	D	4	5	6.3	8	10
Height	A	5~11	7~11	8~11	8~11.5	12.5
Lead Diameter	d±0.05	0.45~0.6	0.45~0.6	0.45~0.6	0.6	0.6
Component Spacing	P±1.0	12.7	12.7	12.7	12.7	12.7
Pitch of sprocket holes	P0±0.2	12.7	12.7	12.7	12.7	12.7
Distance between centers of terminal and the sprocket holes	P1±0.5	5.35	5.35	5.1	4.6	3.85
Distance between centers of the component and the sprocket holes	P2±1.0	6.35	6.35	6.35	6.35	6.35
Distance between centers of component leads	F ^{+0.8} _{-0.5}	2.0	2.0	2.5	3.5	5.0
Carrier tape width	W±0.5	18.0	18.0	18.0	18.0	18.0
Hold down tape width	W0	7.0min	7.0min	7.0min	7.0min	7.0min
Distance between the center of upper edge of carrier tape and sprocket hole	W1±0.5	9.0	9.0	9.0	9.0	9.0
Distance between the upper edges of the carrier tape and the hold down tape	W2	3max	3max	3max	3max	3max
Distance between the abscissa and the bottom of the components body	H ^{+0.75} _{-0.5}	18.5	18.5	18.5	18.5	18.5
Distance between the abscissa and the reference plane of the components with crimped leads	H0±0.5	-	-	-	-	-
Max. lateral deviation of the component body vertical to the tape plane	Δh±1.0	0	0	0	0	0

Lead Forming Specifications

成型產品規格

CB Type



(Unit: mm)					
Shape Code	ΦD	5	6.3	8	10
CB	F	2.0	2.5	3.5	5.0
	H	3.2	3.2	3.2	3.2
	Φd±0.05	L<8mm, d≤0.5 L≥8mm, d=0.6			